### 506074312 05/25/2020

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HUNG-LI CHIANG	05/05/2020
CHAO-CHING CHENG	05/05/2020
CHIH-SHENG CHANG	05/06/2020
TZU-CHIANG CHEN	05/05/2020
JIN CAI	05/06/2020

#### RECEIVING PARTY DATA

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City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300-78

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16880998

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 089436-US-PA

NAME OF SUBMITTER: BELINDA LEE

SIGNATURE: /Belinda Lee/

DATE SIGNED: 05/25/2020

**Total Attachments: 3** 

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the application.

# DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

OR				
Declaration Submitted After Initial Filing	(surcharge 37 CFR 1.16(f) required)			
(Title of the Invention)				
MEMORY DEVICE AND MULTI-LEVEL MEMORY CELL HAVING FERROELECTRIC STORAGE ELEMENT AND MAGNETO-RESISTIVE STORAGE ELEMENT				
As a below named inventor (hereinafter designated as the undersigned), I hereby				
declare that:				
This declaration is directed to:				
☑ The attached application,				
OR				
United States Application Number or PC	CT International application number			
Filed on				

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I believe I am the original inventor or an original joint inventor of a claimed invention in

The above-identified application was made or authorized to be made by me.

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# DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS, 1. Taiwan Semiconductor Manufacturing Co., Ltd.

Of No.8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu, Taiwan 300-78, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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**RECORDED: 05/25/2020** 

## **DECLARATION AND ASSIGNMENT**

# FOR UTILITY OR DESIGN PATENT APPLICATION

Signature: Hung - hi Cherry	Date: 2023.5.5				
Legal Name of Sole or First Inventor: <b>Hung-Li Chiang</b>					
Residence: Taipei City, Taiwan					
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Signature: Mao - Ming Meng	Date:				
Legal Name of Additional Joint Inventor, if any: Chao-Ching Che					
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Signature: Chih-Sheng Cha Legal Name of Additional Joint Inventor, if any: Chih-Sheng Cha Residence: Hsinchu, Taiwan Mailing Address: c/o No.8, Li-Hsin Rd. 6, Hsinchu Science Park,	ang				
Signature: 72w Chirary Chen					
Legal Name of Additional Joint Inventor, if any: Tzu-Chiang Chen					
Residence: Hsinchu City, Taiwan					
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Signature: Am Coi	Date: 5/6/2020				
Legal Name of Additional Joint Inventor, if any: <b>Jin Cai</b>					
Residence: Hsinchu City, Taiwan					

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